PC956L0NSZ

PC956L0NSZ

* VDE (VDE0884) approved type is also available as an option

■ Features

- 1. High resistance to noise (CMR:MIN. 15kV/µs)
- 2. High speed response (t_{PHL}:MAX. 400ns, t_{PLH}:MAX. 550ns)
- 3. Standard DIP type
- 4. Isolation voltage (V_{iso (rms)}=5.0kV)
- 5. Recognized by UL, file No. E64380

■ Absolute Maximum Ratings

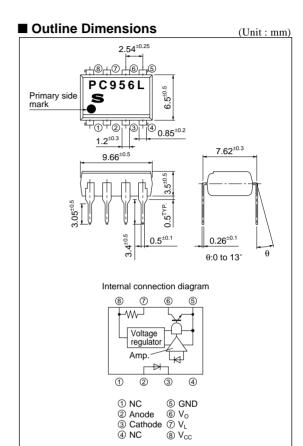
■ Applications

- 1. Programmable controller
- 2. Inverter

= Absolute Maximum (Ta=25 C)							
	Parameter	Symbol	Rating	Unit			
	*1 Forward current	I_F	25	mA			
Input	Reverse voltage	V_R	5	V			
	*2 Power dissipation	P	45	mW			
	Output current	I_{O}	15	mA			
Output	Supply voltage	V_{CC}	-0.5 to +35	V			
Output	Output voltage	Vo	-0.5 to +35	V			
	*3 Power dissipation	Po	100	mW			
*4 Isolat	*4 Isolation voltage		5.0	kV			
Operating temperature Storage temperature *5 Soldering temperature		T_{opr}	-40 to +100	°C			
		T_{stg}	-55 to +125	°C			
		T_{sol}	270	°C			

(T -25°C)

High Speed and High CMR *OPIC Photocoupler



* "OPIC" (Optical IC) is a trademark of the SHARP Corporation.

An OPIC consists of a light-detecting element and signalprocessing circuit integrated onto a single chip.

^{*1} When ambient temperature goes above 70°C, the power dissipation goes down at $0.45 \text{mA}/^{\circ}\text{C}$

^{*2} When ambient temperature goes above 70°C, the power dissipation goes down at 0.8mW/°C

^{*3} When ambient temperature goes above 70°C, the power dissipation goes down at 1.8mW/°C

^{*4 40} to 60% RH, AC for 1 minute

^{*5} For 10s

■ Electro-optical Characteristics *6

(unless otherwise specified $T_a=-40$ to +100°C, $V_{CC}=4.5$ to 35V)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		$V_{\rm F}$	$T_a=25^{\circ}C, I_F=10mA$	-	1.6	1.95	V
	Reverse current		I_R	T _a =25°C, V _R =5V	_	_	10	μΑ
	Terminal capacitance		Ct	$T_a=25$ °C, $V_R=0$, $f=1$ MHz	-	60	250	pF
Output	Supply voltage		V_{CC}	_	4.5	-	35	V
	Low level output voltage		V_{OL}	I _F =10mA, I _o =2.4mA	-	0.3	0.6	V
	Low level output current		I_{OL}	I _F =10mA, V _o =0.6V	4.4	9	_	mA
	High level output current		I_{OH}	$I_F=0, V_{CC}=V_o$	-	5	50	μΑ
	High level supply current		I_{CCH}	$I_F=0, V_o=OPEN$	_	0.6	1.3	mA
	Lo	Low level supply current		I _F =10mA, V _o =OPEN	-	0.8	1.3	mA
cs	"High-Low" threshold input current		I_{FHL}	$V_o \!\!=\!\! 0.8V, R_L \!\!=\!\! 20k\Omega, V_{CC} \!\!=\!\! 15V$ Short circuit between Pin \odot and Pin \odot	-	1.5	5	mA
	Isolation resistance		R _{ISO}	T _a =25°C, DC500V, 40 to 60%RH	5×10 ¹⁰	10^{11}	_	Ω
	Floating capacitance		$C_{\rm f}$	T _a =25°C, V=0, f=1MHz	-	0.6	1	pF
	Internal pull-up resistance		R_{L}	$T_a=25^{\circ}C$	14	20	25	kΩ
risti	ne	*8 "High→Low" propagation time	t_{PHL}	$I_F=10mA (t_{pHL}), I_F=0 (t_{pLH}),$	30	210	400	ns
icte	tin	*8 "Low→High" propagation time	t _{PLH}	V_{CC} =15V, R_L =20k Ω , C_L =100pF	270	400	550	ns
hara	odsa	*7 Distortion of pulse width	Δtw	$V_{THLH}=2.0V$, $V_{THHL}=1.5V$	-	190	450	ns
Transfer characteristics		Propagation delay difference between any two parts	T_{PSK}	Short circuit between Pin ① and Pin ⑧	-150	200	450	ns
	AR.	*9 Instantaneous common mode rejection voltage "Output : High level"	СМн	$\begin{array}{l} T_a \!\!\!=\!\! 25^\circ C, \;\; I_F \!\!\!=\!\! 0, \; V_{CC} \!\!\!=\!\! 15V, \; C_L \!\!\!=\!\! 100pF, \\ V_{CM} \!\!\!=\!\! 1.5kV_{(P\!-P\!)}, \; R_L \!\!\!\!=\!\! 20k\Omega, \; V_O \!\!\!>\!\! 3.0V, \\ Short circuit between Pin \odot and Pin \odot$	15	30	_	kV/μs
	CMR	*9 Instantaneous common mode rejection voltage "Output : Low level"	CM_L	$\begin{array}{c} T_a \!\!=\!\! 25^\circ C, I_F \!\!=\!\! 10 mA, V_{CC} \!\!=\!\! 15 V,\\ C_L \!\!=\!\! 100 pF, V_{CM} \!\!=\!\! 1.5 kV_{(P\!-P)}, R_L \!\!=\!\! 20 k\Omega,\\ V_0 \!\!<\!\! 1.0 V, Short circuit between\\ Pin \textcircled{?} and Pin \textcircled{\$} \end{array}$	-15	-30	_	kV/μs

^{*6} It shall connect a by-pass capacitor of $0.01\mu F$ or more between V_{CC} (Pin 8) and GND (Pin 5) near the device, when it measures the transfer characteristics and the output side characteristics

■ Recommended Operating Conditions

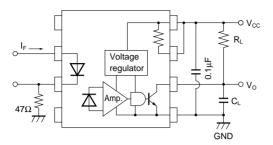
	<u>. </u>				
Parameter	Symbol	MIN.	MAX.	Unit	
Forward current	I_{F}	10	20	mA	
Supply voltage	V _{CC}	4.5	35	V	
Output voltage	Vo	0	35	V	
Operating temperature	Topr	-40	100	°C	

^{*7} Distortion of pulse width $\Delta tw = |t_{PHL} - t_{PLH}|$

^{*8} Refer to Fig.1

^{*9} Refer to Fig.2

Fig.1 Test Circuit for t_{PHL} and t_{PLH}



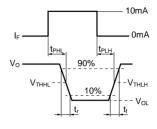
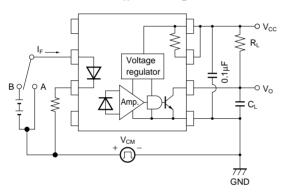


Fig.2 Test Circuit for CM_H and CM_L



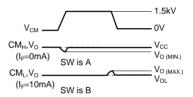


Fig.3 Forward Current vs. Ambient Temperature

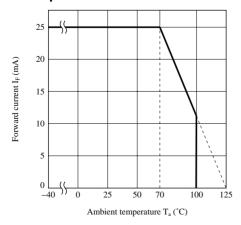


Fig.4 Power Dissipation vs. Ambient Temperature

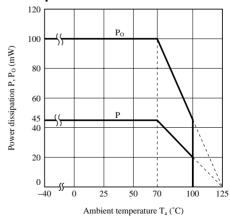


Fig.5 Output Current vs. Forward Current

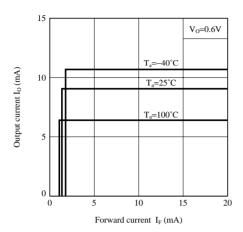


Fig.7 Relative Output Current vs. Ambient Temperature

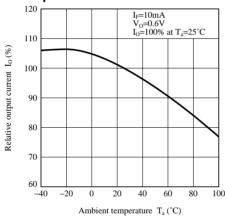


Fig.9 Low Level Output Voltage vs. Ambient Temperature

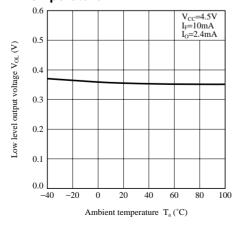


Fig.6 Forward Current vs. Forward Voltage

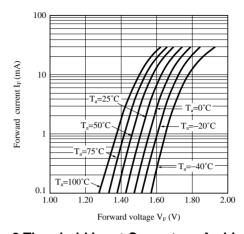


Fig.8 Threshold Input Current vs. Ambient Temperature

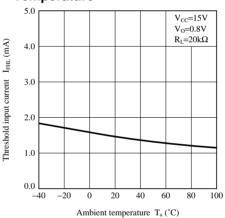
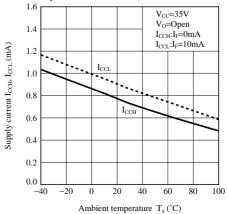


Fig.10 Supply Current vs. Ambient Temperature



SHARP PC956L0NSZ

Fig.11 Propagation Delay Time vs.
Ambient Temperature

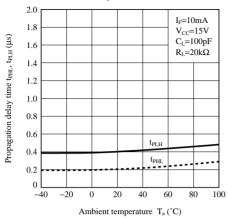


Fig.13 Propagation Delay Time vs. Load Capacitance

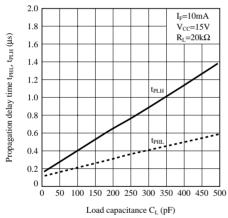


Fig.15 Propagation Delay Time vs. Forward Current

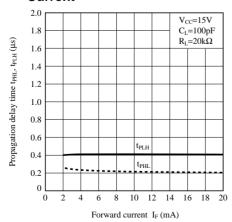


Fig.12 Propagation Delay Time vs. Load Resistance

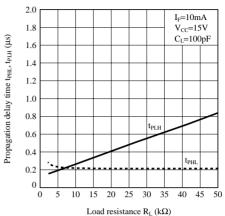
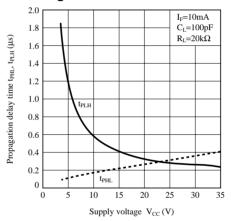


Fig.14 Propagation Delay Time vs. Supply Voltage



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